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Docket No. 0756-2218

2829

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of ) Art Unit: 2829  
Hongyong ZHANG et al. ) Examiner: E. Pert  
Serial No. 09/695,414 )  
Filed: October 25, 2000 )  
For: METHOD FOR FORMING )  
SEMICONDUCTOR DEVICE )

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence is being deposited with The United States Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on 12-31-03

*Adelle M. Stamps*

**RESPONSE TO NOTICE OF ABANDONMENT**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

Applicant's representative received a *Notice of Abandonment* from the U.S. Patent Office mailed December 23, 2003 in the above-identified application. The *Notice of Abandonment* was issued because "Applicant seemingly failed to file an Appeal Brief within 2 months following the "Notice of Appeal" filed 6-25-03."

In response to the *Notice of Appeal* dated June 25, 2003, an Appeal Brief was filed on August 25, 2003. Enclosed please find a copy of the PTO stamped receipt card evidencing receipt of the Brief.

In view of the above and the enclosed document, it is believed that the *Notice of Abandonment* was issued in error. Therefore, it is respectfully requested that the *Notice of Abandonment* be rescinded. Should a further copy of the Brief be required, it is requested that the undersigned be contacted to coordinate such submission.

Respectfully submitted,

Eric J. Robinson  
Reg. No. 38,285

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This will acknowledge receipt of the following:

1. Transmittal Form/Fee Transmittal (2 copies)
2. Appeal Brief (in triplicate)
3. Check No. 2324 in the amount of \$320.00 (appeal brief)
4. Certificates of Mailing for each of the above

In re PATENT application of:

HONGYONG ZHANG et al  
Serial No. 09/695,414  
Filed: 10/25/2000  
Due Date: 08/24/2003  
For: METHOD FOR FORMING SEMICONDUCTOR DEVICE  
Docket: 0756-2218  
August 25, 2003  
EJR/EJR/ams



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9/13/03